

# ATR240 Series

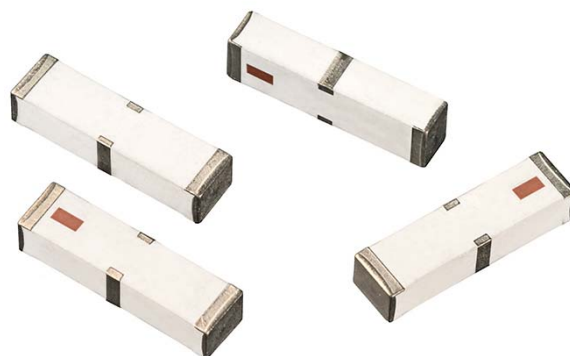
## Multilayer Chip Antenna

### Features

- ❖ Monolithic SMD with small, low-profile and light-weight type.
- ❖ Wide bandwidth
- ❖ RoHS compliant

### Applications

- ❖ GPS Modules, etc.



### Specifications

Part Number	Operating Frequency (MHz)	Peak Gain (dBi typ.)	Average Gain (dBi typ.)	VSWR	Impedance
<b>ATR240-A1R5HCA_</b>	1570~1580	1.3 (YZ-Total)	-0.7 (YZ-Total)	2 max.	50 Ω

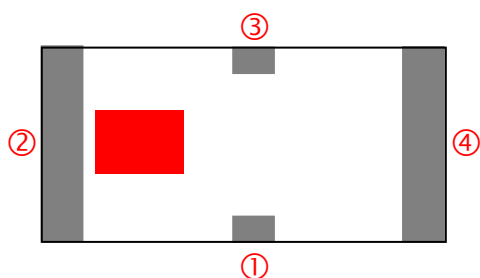
Q'ty/Reel (pcs) : 500 pcs  
 Operating Temperature Range : -40 ~ +85 °C  
 Storage Temperature Range : -40 ~ +85 °C  
 Storage Period : 12 months max.  
 Power Capacity : 2W max.

### Part Number

**AT**   **R240**   -   **A**   **1R5**   **HCA**   **□**   **/LF**  
 ①   ②   ③   ④   ⑤   ⑥   ⑦

① Type	AT : Antenna	② Dimensions ( L x W )	15.0x 4.0 mm
③ Material Code	A	④ Initial center frequency	1R5=1575MHz
⑤ Specification Code	HCA	⑥ Packaging	T: Tape & Reel B: Bulk
⑦ Soldering	/LF=lead-free		

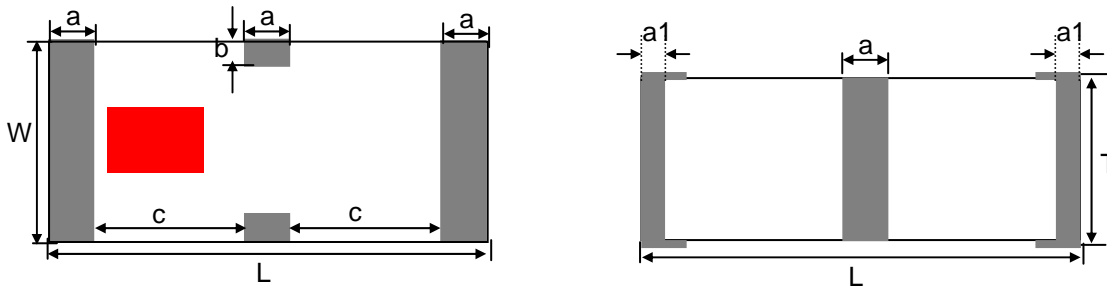
### Terminal Configuration



No.	Terminal Name	No.	Terminal Name
①	Feeding point	③	NC
②	GND	④	GND

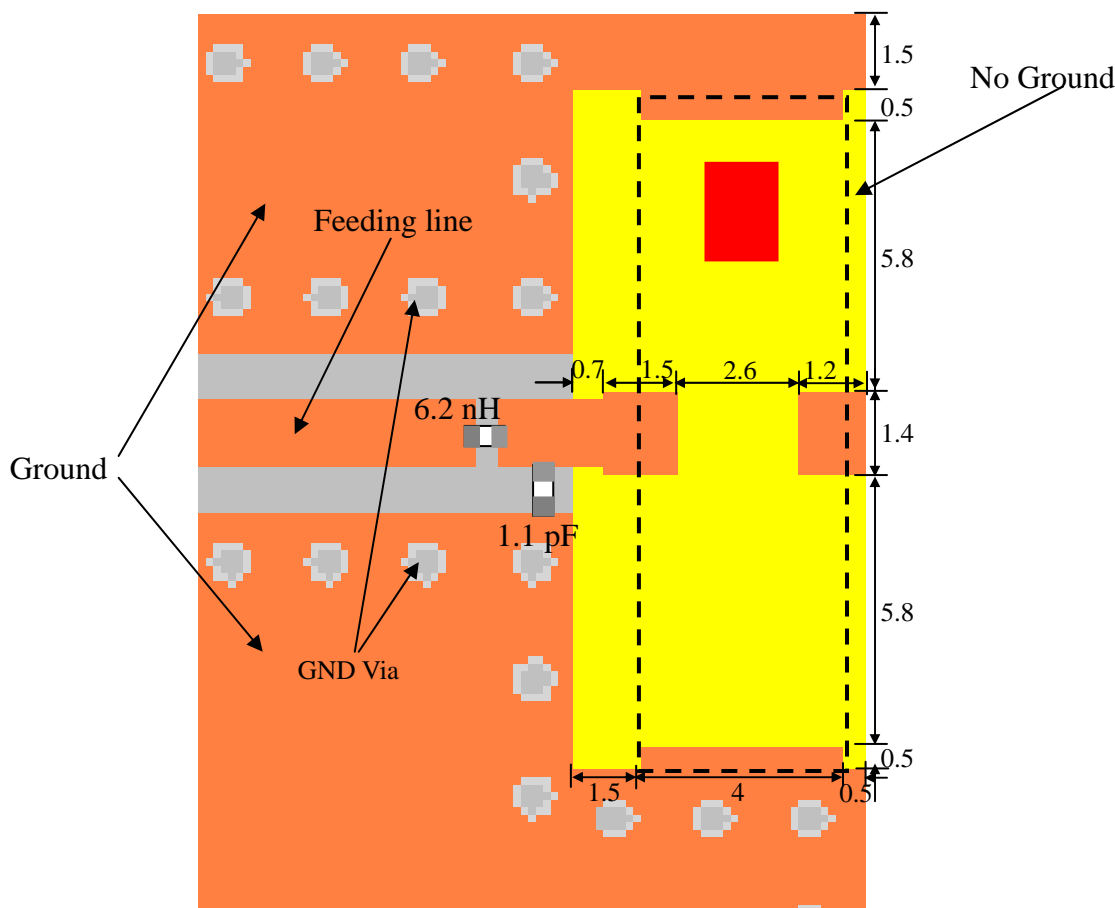
**Dimensions and Recommended PC Board Pattern**

Unit : mm



Mark	L	W	T	a	a1	b	c
Dimensions	15.0±0.2	4.0±0.2	3.2±0.2	1.0±0.2	0.5±0.2	0.5±0.2	6.0±0.2

❖ Without Matching Circuits (Unit in mm)

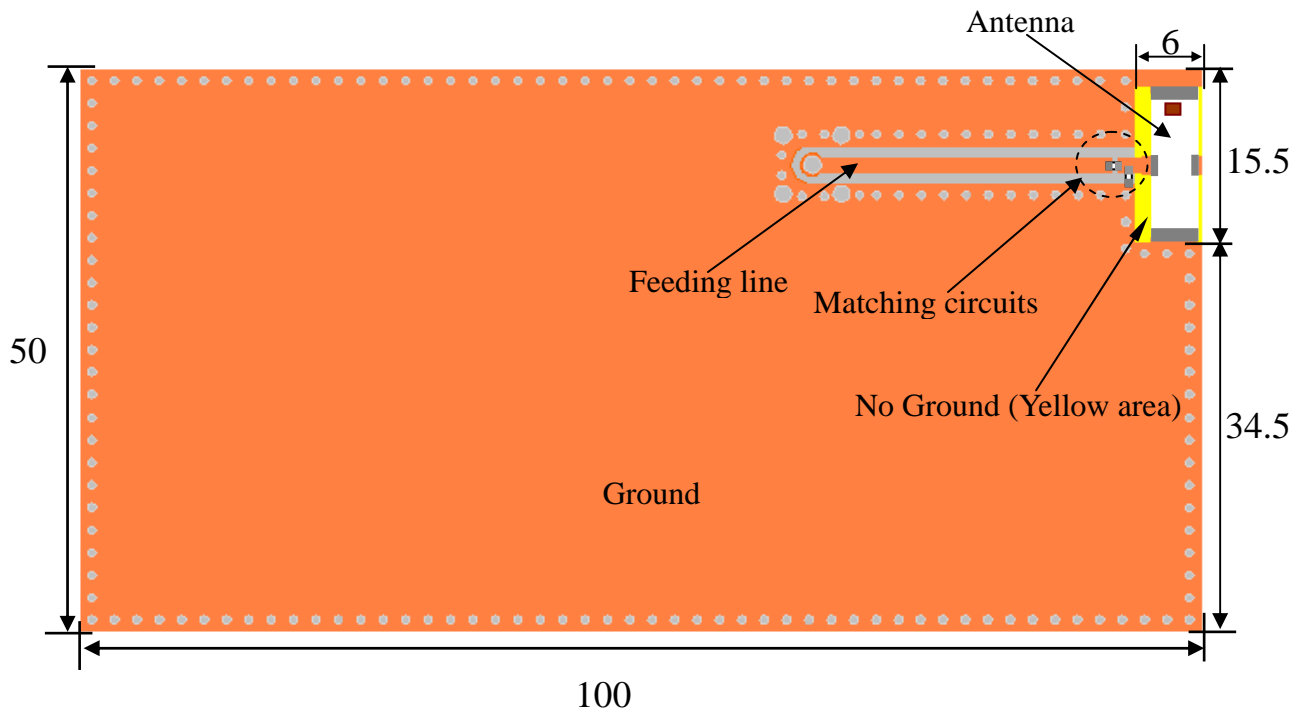


(Matching circuit and component values will be different, depending on PCB layout)

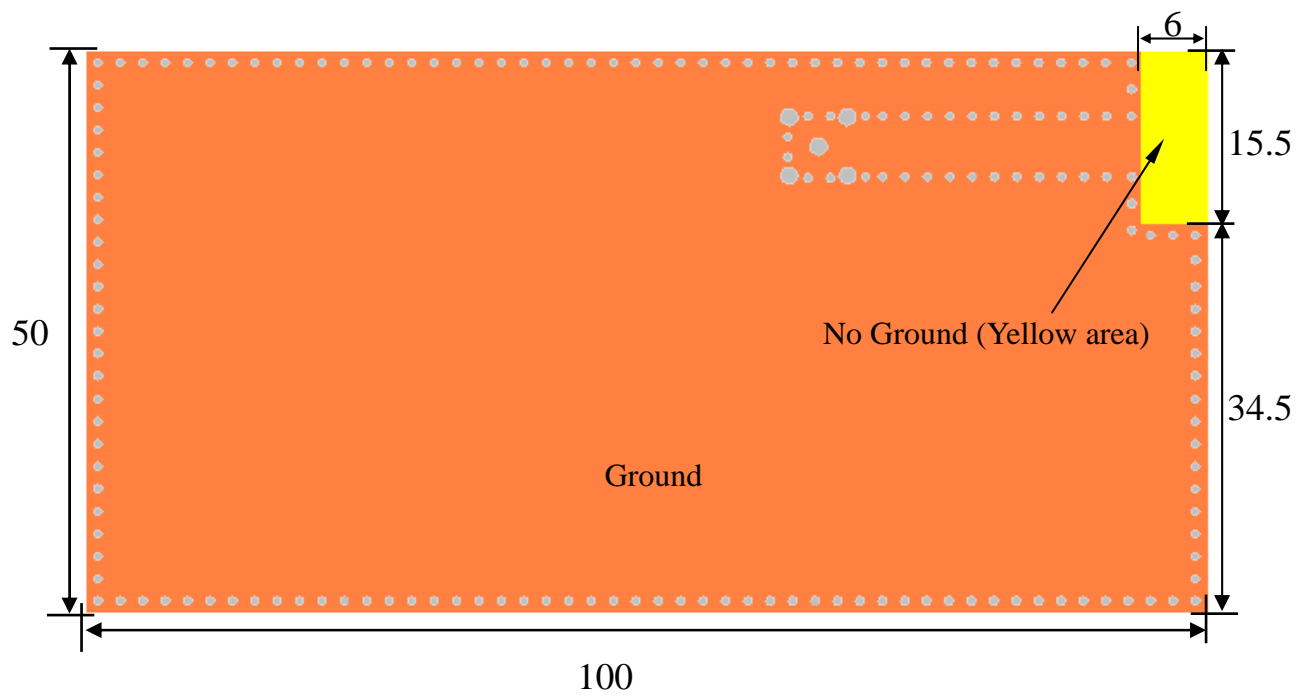
\*Line width should be designed to match 50Ω characteristic impedance, depending on PCB material and thickness.

Typical Electrical Characteristics (T=25°C)

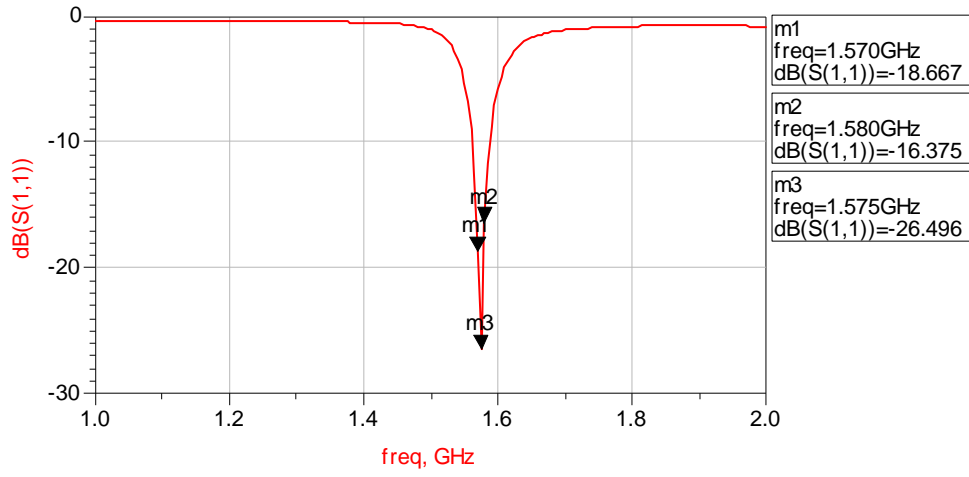
❖ Test Board-Top View (Unit in mm)



❖ Test Board-Bottom View (Unit in mm)



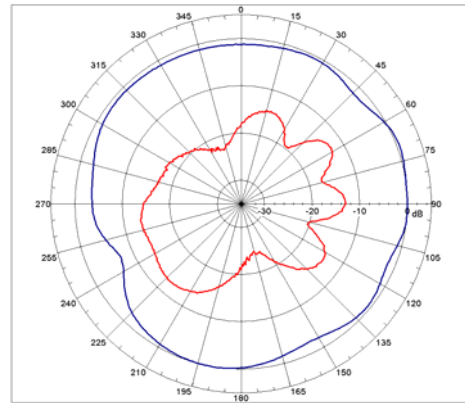
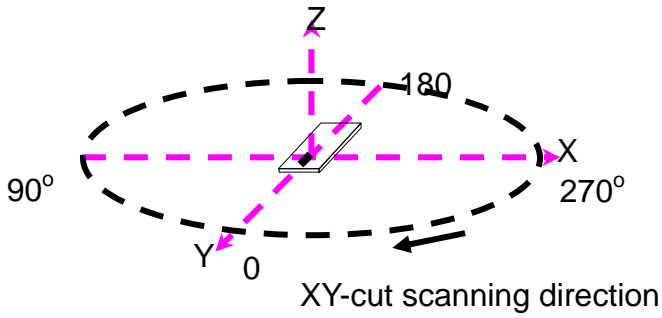
❖ Return Loss / Without Matching Circuits



❖ Radiation Patterns

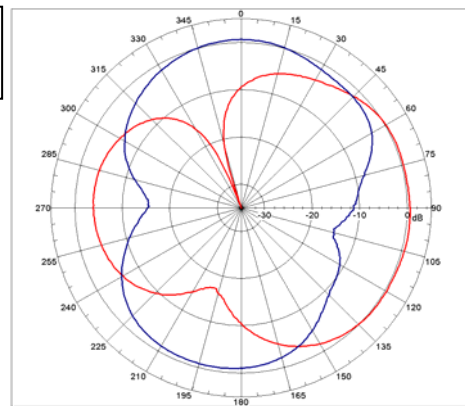
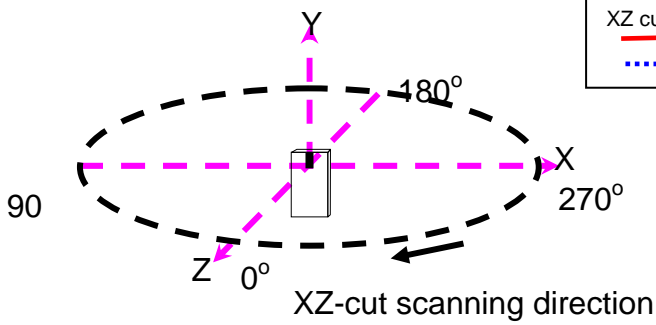
XY-V/XY-H

XY cut @ 1.575GHz  
— Vertical  
⋯ Horizontal



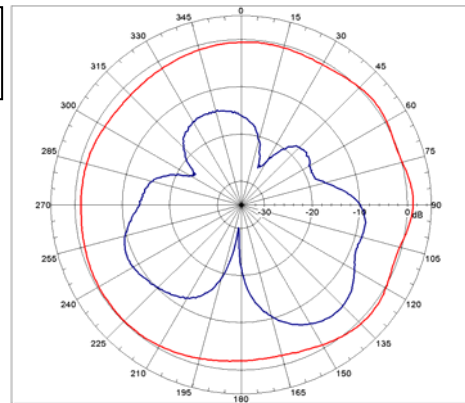
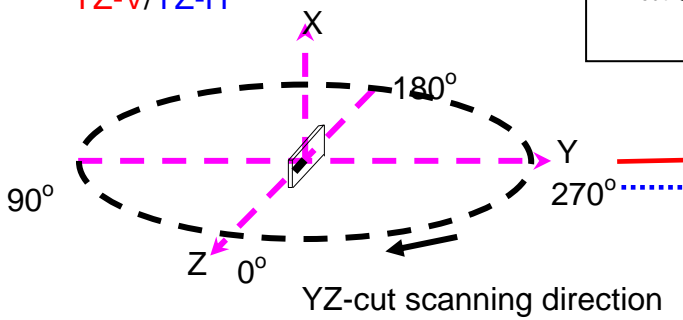
XZ-V/XZ-H

XZ cut @ 1.575GHz  
— Vertical  
⋯ Horizontal



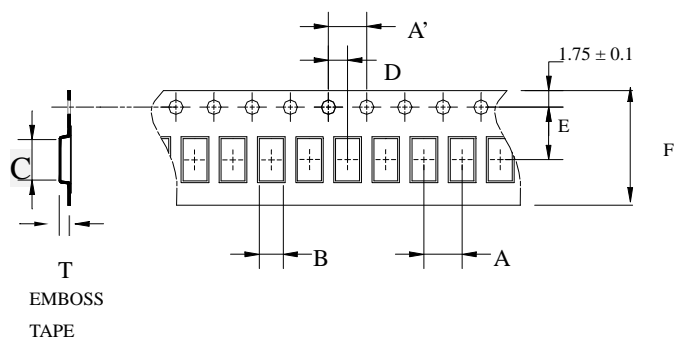
YZ-V/YZ-H

YZ cut @ 1.575GHz  
 Vertical  
 Horizontal



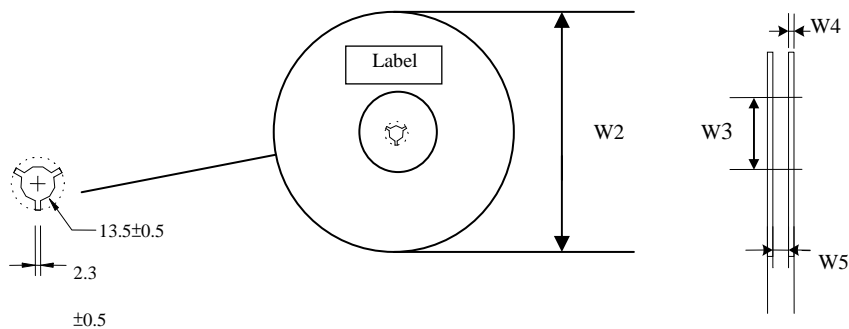
## Taping Specifications

### ❖Tape & Reel Dimensions (Unit: mm) vs. Quantity (pcs)



Type	A	A'	B	C	D	E	F	T	Quantity/per reel	Tape material
ATR240	8.0±	4.0±	4.35±	15.4±	2.0±	11.5±	24.0±	3.50±	500pcs	Plastic (Embossed)
	0.1	0.1	0.1	0.1	0.1	0.1	0.3	0.1		

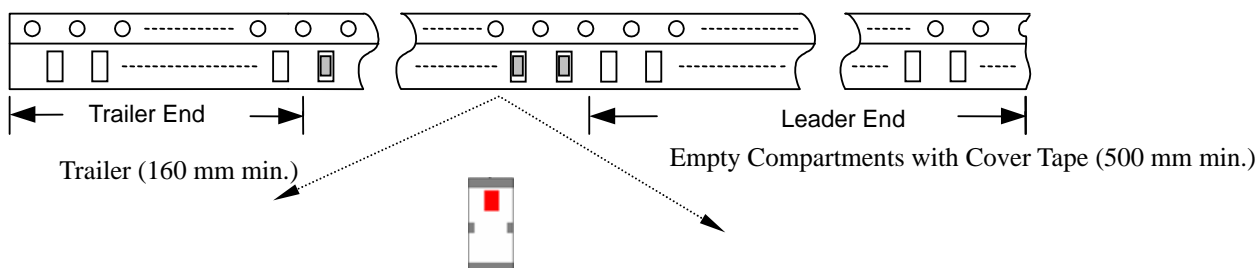
### ❖Reel Dimensions (Unit: mm)



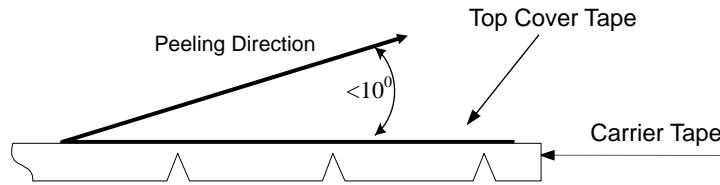
Label: Customer's Name,  
ACX P/N, Q'ty, Date,  
ACX Corp.

Type	W2	W3	W4	W5
ATR240	330±2	178±2	2.0±0.2	45±0.5

### ❖Leader and Trailer Tape



❖ **Peel-off Force**



Peel-off force should be in the range of 0.2 – 1.20 N at a peel-off speed of  $300 \pm 10$  mm/min .

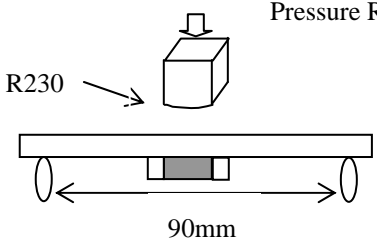
❖ **Storage Conditions**

- (1) Temperature: 5 ~35°C , relative humidity (RH): 45~75%.
- (2) Non-corrosive environment

**Notes**

❖ The contents of this data sheet are subject to change without notice. Please confirm the specifications and delivery conditions when placing your order.

## Mechanical & Environmental Characteristics

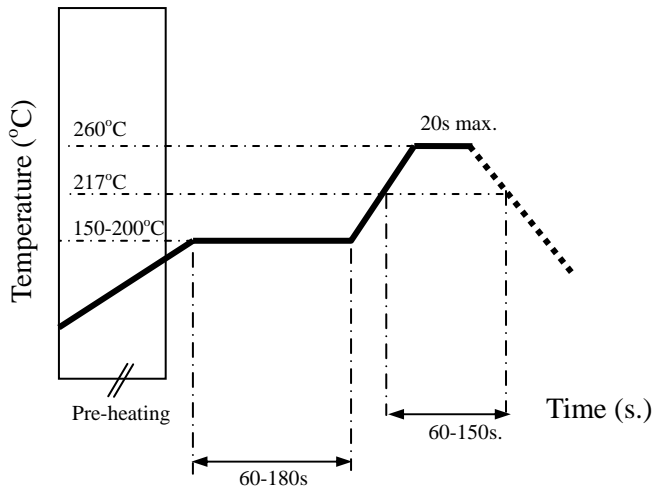
Item	Requirements	Procedure
Solderability	<ol style="list-style-type: none"> <li>No apparent damage</li> <li>More than 95% of the terminal electrode shall be covered with new solder</li> </ol>	<ol style="list-style-type: none"> <li>Preheat: <math>120 \pm 5^\circ\text{C}</math></li> <li>Solder: <math>245 \pm 5^\circ\text{C}</math> for <math>5 \pm 1</math> sec</li> </ol>
Soldering strength (Termination Adhesion)	<ol style="list-style-type: none"> <li>10N minimum</li> </ol>	<ol style="list-style-type: none"> <li>Solder specimen onto test jig.</li> <li>Apply push force at 0.5mm/s until electrode pads are peeled off or ceramic are broken. Pushing force is applied to longitude direction</li> </ol>
Deflection (Substrate Bending)	<ol style="list-style-type: none"> <li>No apparent damage</li> </ol>	<ol style="list-style-type: none"> <li>Solder specimen onto test jig (FR4, 0.8mm) using the recommend soldering profile.</li> <li>Apply a bending force of 1mm deflection</li> </ol> 
Heat/Humidity Resistance	<ol style="list-style-type: none"> <li>No apparent damage</li> <li>Fulfill the electrical specification after test</li> </ol>	<ol style="list-style-type: none"> <li>Temperature: <math>85 \pm 2^\circ\text{C}</math></li> <li>Humidity: 90% ~ 95% RH</li> <li>Duration: <math>1000 \pm 48</math>hrs</li> <li>Recovery: 1-2hrs</li> </ol>
Thermal shock (Temperature Cycle)	<ol style="list-style-type: none"> <li>No apparent damage</li> <li>Fulfill the electrical specification after test</li> </ol>	<ol style="list-style-type: none"> <li>One cycle/step 1 : <math>125 \pm 5^\circ\text{C}</math> for 30 min step 2 : <math>-40 \pm 5^\circ\text{C}</math> for 30 min</li> <li>No of cycles : 100</li> <li>Recovery: 1-2 hrs</li> </ol>
Low Temperature Resistance	<ol style="list-style-type: none"> <li>No apparent damage</li> <li>Fulfill the electrical specification after test</li> </ol>	<ol style="list-style-type: none"> <li>Temperature: <math>-40 \pm 5^\circ\text{C}</math></li> <li>Duration: <math>500 \pm 24</math>hrs</li> <li>Recovery: 1-2hrs</li> </ol>



## Soldering Conditions

### ❖ Typical Soldering Profile for Lead-free Process

Reflow Soldering :



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